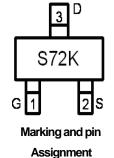


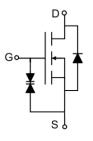
Main Product Characteristics:

V _{DSS}	60V
R _{DS} (on)	2Ω(max.)
I _D	0.3A



SOT-23





Schematic diagram

Features and Benefits:

- Advanced MOSFET process technology
- Special designed for PWM, load switching and general purpose applications
- Ultra low on-resistance with low gate charge
- Fast switching and reverse body recovery
- ESD Rating: 1000V HBM
- 150°C operating temperature



Description:

It utilizes the latest processing techniques to achieve the high cell density and reduces the on-resistance with high repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in power switching application and a wide variety of other applications.

Absolute max Rating:

Symbol	Parameter	Max.	Units
I _D @ TC = 25°C	Continuous Drain Current, V _{GS} @ 10V①	0.3	^
I _{DM}	Pulsed Drain Current②	1.2	A
P _D @TC = 25°C	Power Dissipation③	0.63	W
V _{DS}	Drain-Source Voltage	60	V
V _{GS}	Gate-to-Source Voltage	± 20	V
T _J T _{STG}	Operating Junction and Storage Temperature Range	-55 to +150	°C

Thermal Resistance

Symbol	Characterizes	Тур.	Max.	Units
R ₀ JA	Junction-to-ambient (t ≤ 10s) ④	_	200	°C/W





Electrical Characterizes $@T_A=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source breakdown voltage	60	_	_	V	V _{GS} = 0V, ID = 250μA
В	Static Drain-to-Source on-resistance	_	1.5	2	0	V _{GS} =10V, I _D =0.5A
R _{DS(on)}	Static Dialii-to-Source on-resistance	_	_	3	Ω	V _{GS} =5V, I _D =0.05A
$V_{GS(th)}$	Gate threshold voltage	1	_	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
I _{DSS}	Drain-to-Source leakage current	_	_	1	μA	$V_{DS} = 60V, V_{GS} = 0V$
	Gate-to-Source forward leakage	_	_	±100	nA	V _{GS} =±5V,V _{DS} =0V
I _{GSS}	Gate-to-Source forward leakage	_	_	±10	uA	$V_{GS}=\pm20V, V_{DS}=0V$
t _{d(on)}	Turn-on delay time	_	_	25	no	V _{GS} =10V, VDS=30V,
t _{d(off)}	Turn-Off delay time	<u> </u>	_	35	$ID=0.2A,R_{GEN}=10\Omega$	
C _{iss}	Input capacitance	_	40	_		V _{GS} = 0V
Coss	Output capacitance	_	16.6	_	pF	V _{DS} = 25V
C _{rss}	Reverse transfer capacitance	_	9.5	_		f = 1MHz

Source-Drain Ratings and Characteristics

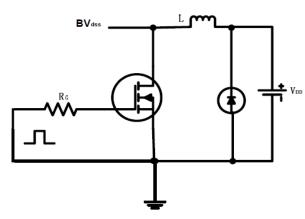
Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
	Continuous Source Current			0.3	۸	MOSFET symbol
IS	(Body Diode)	_	_	0.3	А	showing the
	Pulsed Source Current			1.2	^	integral reverse
I _{SM}	(Body Diode)	_	_	1.2	А	p-n junction diode.
V _{SD}	Diode Forward Voltage	_	_	1.3	V	I _S =0.2A, V _{GS} =0V

Version: 1.0

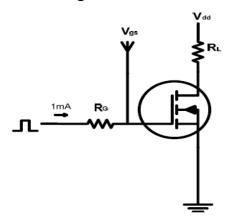


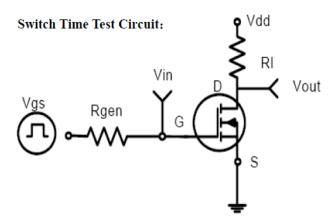
Test circuits and Waveforms



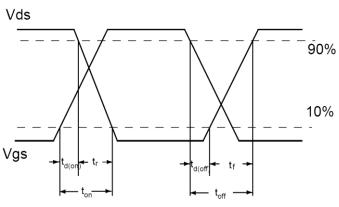


Gate charge test circuit:





Switch Waveforms:



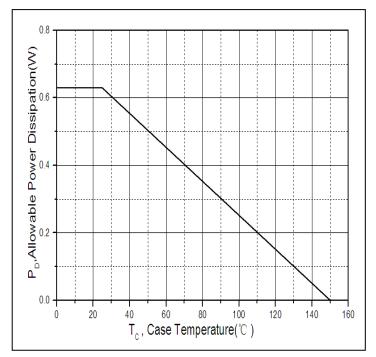
Version: 1.0

Notes:

- ①The maximum current rating is limited by bond-wires.
- ②Repetitive rating; pulse width limited by max. junction temperature.
- ③The power dissipation PD is based on max. junction temperature, using junction-to-case thermal resistance.
- 4The value of $R_{\theta JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25°C
- ⑤These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}=150$ °C.



Typical electrical and thermal characteristics



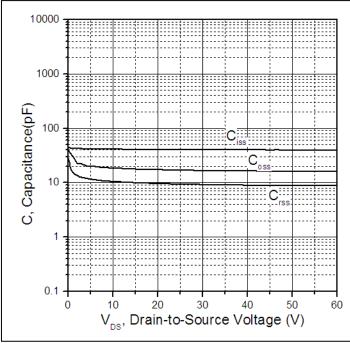


Figure 1. Power Dissipation Vs. Case Temperature

Figure 2.Typical Capacitance Vs. Drain-to-Source Voltage

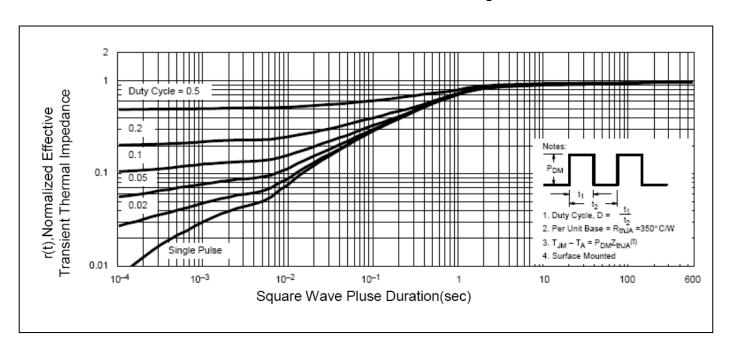
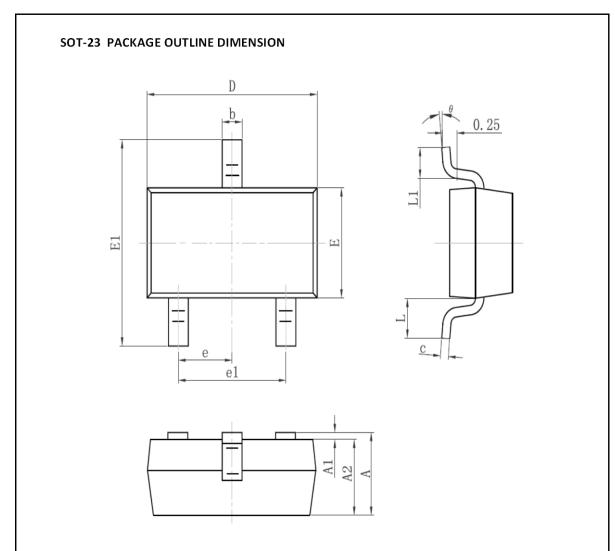


Figure 3. Maximum Effective Transient Thermal Impedance, Junction-to-Case



Mechanical Data:



Symbol	Dimension I	Dimension In Millimeters		n In Inches
Sylfibol	Min	Max	Min	Max
Α	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
С	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
Е	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
е	0.95	TYP	0.03	7TYP
e1	1.800	2.000	0.071	0.079
L	0.55REF		0.02	2REF
L1	0.300	0.500	0.012	0.020
θ	00	80	00	8 ⁰





Ordering and Marking Information

Device Marking: S72K

Package (Available)
SOT-23
Operating Temperature Range
C: -55 to 150 °C

Devices per Unit

Package	Units/	Tapes/Inner	Units/Inner	Inner	Units/
Type	Tape	Box	Box	Boxes/Carton	Carton
				Box	Box

Reliability Test Program

Test Item	Conditions	Duration	Sample Size
High	T _j =125℃ to 150℃ @	168 hours	3 lots x 77 devices
Temperature	80% of Max	500 hours	
Reverse	V _{DSS} /V _{CES} /VR	1000 hours	
Bias(HTRB)			
High	T _j =150℃ @ 100% of	168 hours	3 lots x 77 devices
Temperature	Max V _{GSS}	500 hours	
Gate		1000 hours	
Bias(HTGB)			



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